

FGH60N60UFD 600V, 60A Field Stop IGBT

Features

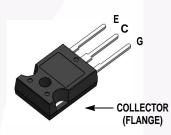
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.9 V @ I_C = 60 A
- High Input Impedance
- Fast Switching
- RoHS Compliant

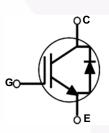
Applications

• Solar Inverter, UPS, Welder and PFC

General Description

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage Transient Gate-to-Emitter Voltage		±20	V	
			±30	v	
I _C	Collector Current	@ T _C = 25°C	120	A	
	Collector Current	@ T _C = 100°C	60	A	
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	180	A	
P _D	Maximum Power Dissipation	@ T _C = 25 ^o C	298	W	
	Maximum Power Dissipation	@ T _C = 100 ^o C	119	W	
Т _Ј	Operating Junction Temperature		-55 to +150	°C	
T _{stg}	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1: Repetitive test , Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}(IGBT)$	GBT) Thermal Resistance, Junction to Case		0.33	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.1	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

March 2015

Part Number Top Mark Package FGH60N60UFDTU FGH60N60UFD TO-247		Top Mark	Package	Packing Method	Reel Size	Tape Wig	th Q	Quantity	
		Tube	N/A	N/A		30			
Electric	al Cha	aracteristics	s of the IC	GBT $T_{C} = 25^{\circ}C$ unless other	wise noted				
Symbol		Parameter	•	Test Conditio	ns Min	. Тур.	Max.	Unit	
Off Charac	teristics								
BV _{CES}			lown Voltage	V _{GE} = 0 V, I _C = 250 μA	600	-	_	V	
ΔBV_{CES} / ΔT_J		lector to Emitter Breakdown Voltage		$V_{GE} = 0 V, I_C = 250 \mu A$	-	0.67	_	V/°C	
		ctor Cut-Off Current		V _{CE} = V _{CES} , V _{GE} = 0 V			250	μA	
I _{CES} I _{GES}		akage Current		$V_{GE} = V_{GES}, V_{GE} = 0 V$ $V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA	
-GE9	0 - 10								
On Charac	teristics								
V _{GE(th)}	G-E Th	reshold Voltage		$I_C = 250 \ \mu\text{A}, \ V_{CE} = V_{GE}$	4.0	5.0	6.5	V	
				$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}$	-	1.9	2.4	V	
V _{CE(sat)}	Collecto	tor to Emitter Saturation Voltage		$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$	-	2.1	-	V	
Dynamic C	haracte	ristics							
C _{ies}	1	apacitance			-	2855	_	pF	
C _{oes}	-	Capacitance	-	V _{CE} = 30 V _, V _{GE} = 0 V,	-	325	_	pF	
C _{res}		e Transfer Capacita	ance	f = 1 MHz	-	110	-	pF	
Switching	1						1		
t _{d(on)}		n Delay Time		•	-	23	-	ns	
t _r	Rise Tir	-		•	-	58	-	ns	
t _{d(off)}		ff Delay Time		$V_{CC} = 400 \text{ V}, I_{C} = 60 \text{ A},$	-	130	-	ns	
t _f	Fall Tim	-		$R_G = 5 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$		40	80	ns	
Eon		n Switching Loss			-	1.81	-	mJ	
E _{off}		ff Switching Loss		-	-	0.81	-	mJ	
E _{ts}	Total Sv	witching Loss			-	2.62	-	mJ	
t _{d(on)}	Turn-O	n Delay Time		•	-	22	-	ns	
t _r	Rise Tir	ne			-	61	-	ns	
t _{d(off)}	Turn-O	ff Delay Time		$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 60 \text{ A},$	-	141	-	ns	
t _f	Fall Tim	ne	$R_G = 5 \Omega$, V _{GE} = 15 V, Inductive Load, T _C = 125 ^C	-	63	-	ns		
Eon	Turn-O	n Switching Loss			-	1.92	-	mJ	
E _{off}	Turn-Of	ff Switching Loss			-	1.23	-	mJ	
E _{ts}	Total Sv	witching Loss			-	3.15	-	mJ	
Qg	Total G	ate Charge			-	188	-	nC	
Q _{ge}	Gate to	Emitter Charge		$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$ $V_{GE} = 15 \text{ V}$	-	21	-	nC	
Q _{gc}	Gate to	Collector Charge		GE - IO V	-	97	-	nC	

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Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Units
V _{FM}	Diode Forward Voltage	I _F = 30 A	$T_C = 25^{\circ}C$	-	2.0	2.6	V
		1F - 30 A	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.8	-	1
t _{rr}	Diode Reverse Recovery Time		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	47 -	ns	
		I _F = 30 A, di _F /dt = 200 A/μs	$T_{\rm C} = 125^{\rm o}{\rm C}$	-	179	-	110
Q _{rr}	Diode Reverse Recovery Charge	$r_F = 30 \text{ A}, \text{ dif/dt} = 200 \text{ A/}\mu 3$	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	83	-	nC
			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	567	-	





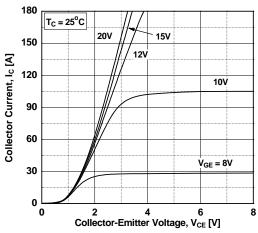


Figure 3. Typical Saturation Voltage Characteristics

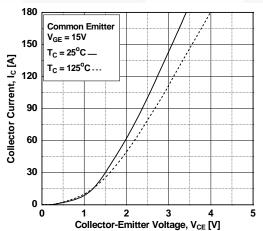


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

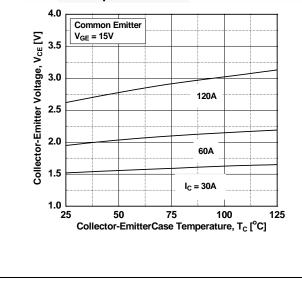


Figure 2. Typical Output Characteristics

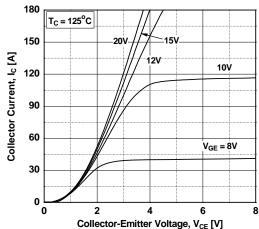


Figure 4. Transfer Characteristics

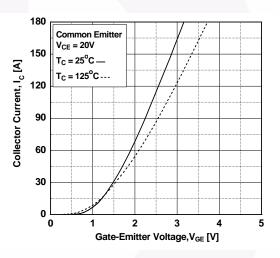
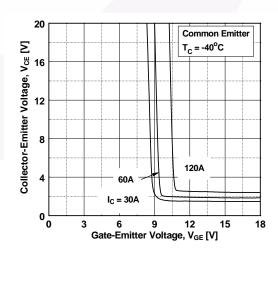
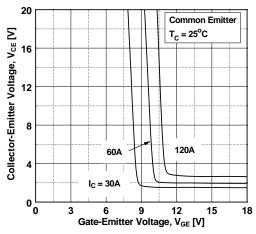


Figure 6. Saturation Voltage vs. V_{GE}



Typical Performance Characteristics







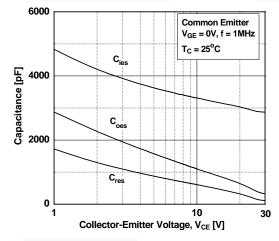


Figure 11. SOA Characteristics

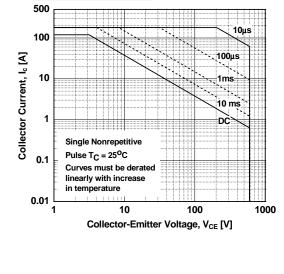


Figure 8. Saturation Voltage vs. V_{GE}

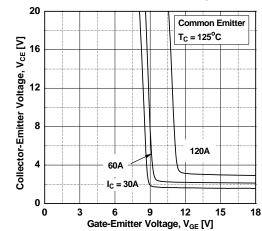
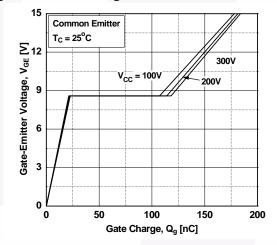
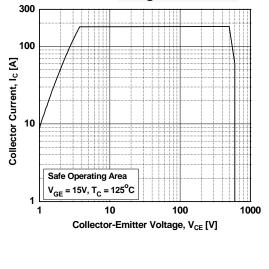
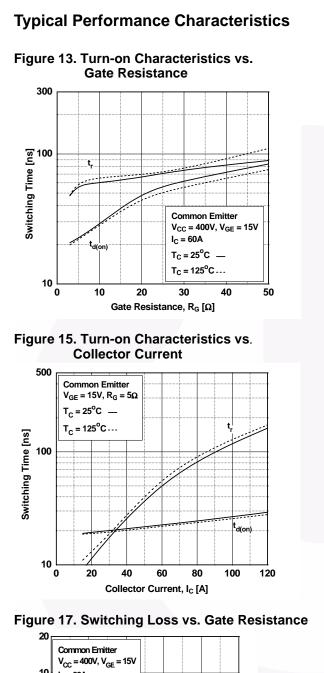


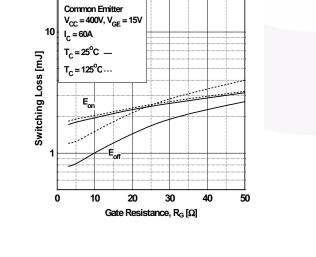
Figure 10. Gate charge Characteristics



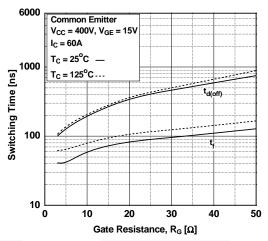


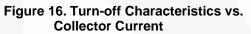












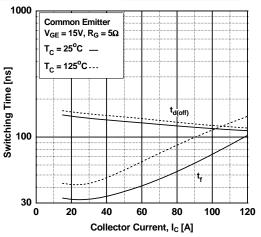
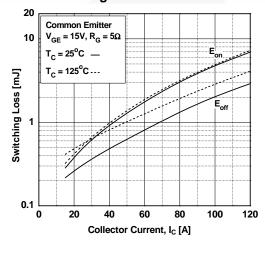
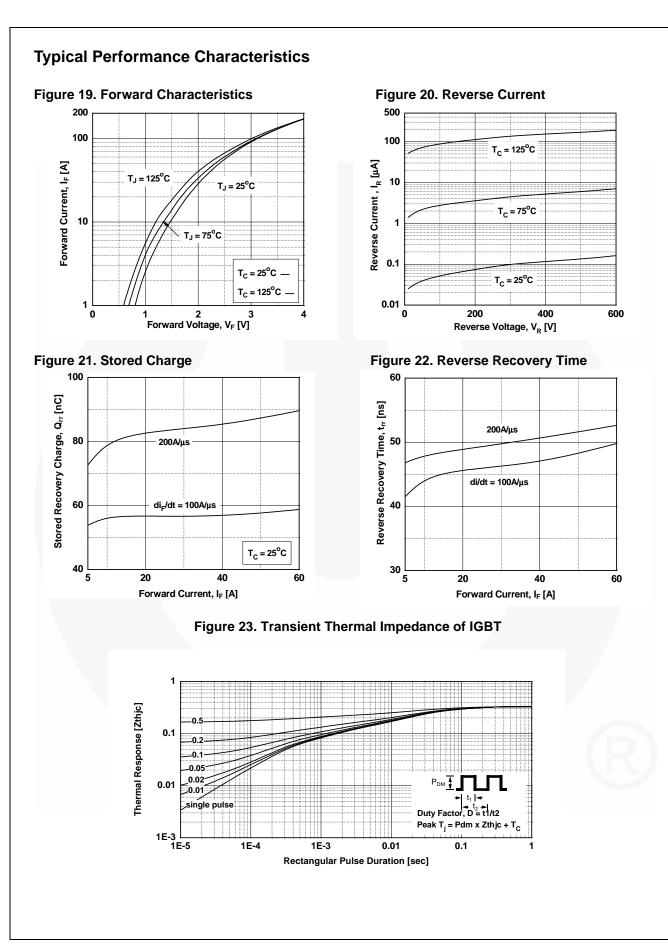
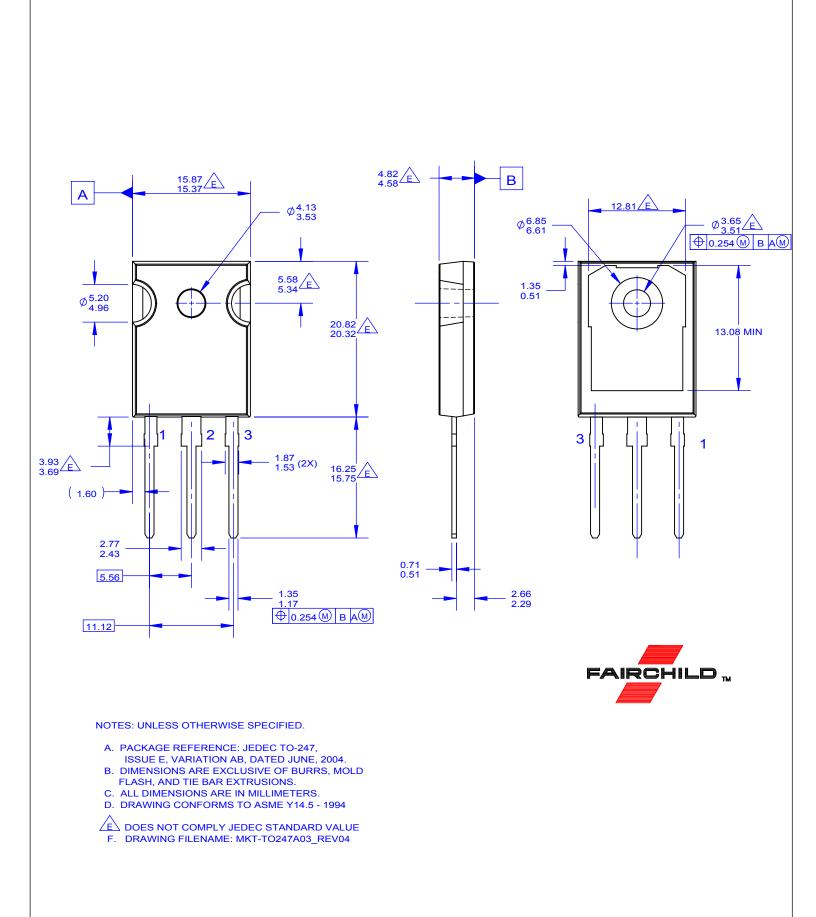


Figure 18. Switching Loss vs. Collector Current







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